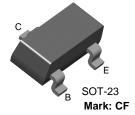


BSS79C

NPN General Purpose Amplifier

- This device is for use as a medium power amplifier and swith requiring collector currents up to 500mA.
- Sourced from process 19.
- See BCW65C for characteristics.



Absolute Maximum Ratings * Ta=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	40	V
V _{CBO}	Collector-Base Voltage	75	V
V _{EBO}	Emitter-Base Voltage	6.0	V
I _C	Collector Current - Continuous	800	mA
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 ~ +150	°C

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

- These ratings are based on a maximum junction temperature of 150 degrees C.
 These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Electrical Characteristics T_a=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Charac	cteristics		•	•	
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage	I _C = 10mA, I _B = 0	75		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = 10\mu A, I_E = 0$	40		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = 10\mu A, I_C = 0$	6.0		V
I _{CBO}	Collector-Cutoff Current	V _{CB} = 60V		10	nA
		$V_{CB} = 60V, T_a = 150^{\circ}C$		10	μΑ
I_{EBO}	Emitter-Cutoff Current	$V_{EB} = 3.0V, I_{C} = 0$		10	nA
On Charac	cteristics *				
h _{FE}	DC Current Gain	I _C = 150mA, V _{CE} = 10V	100	300	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C = 150mA, I _B = 15mA		0.3	V
02(001)		$I_C = 500 \text{mA}, I_B = 50 \text{mA}$		1.0	V
Small Sign	nal Characteristics				
f _T	Current Gain - Bandwidth Product	I _C = 20mA, V _{CE} = 20V, f = 100MHz	x, V _{CE} = 20V, f = 100MHz		MHz
C _{CB}	Collector-Base Capacitance	V _{CB} = 10V, I _E = 0, f = 1.0MHz		8.0	pF
Switching	Characteristics				
t _d	Delay Time	V _{CC} = 30V, V _{BE(OFF)} = 0.5V, I _C = 150mA, I _{B1} = 15mA		10	ns
t _r	Rise Time			10	ns
t _s	Storage Time	V _{CC} = 30V, I _C = 150mA,		265	ns
t _f	Fall Time	$I_{B1} = I_{B2} = 15 \text{mA}$		60	ns

Rev. A, June 2004

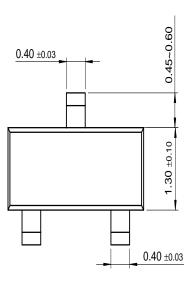
Thermal Characteristics T _a =25°C unless otherwise noted					
Symbol	Parameter	Max.	Units		
P_{D}	Total Device Dissipation Derate above 25°C	350 2.8	mW mW/°C		
R _{e.IA}	Thermal Resistance, Junction to Ambient	357	°C/W		

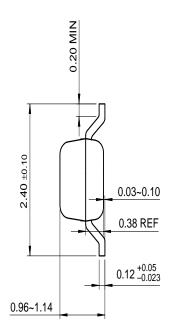
^{*} Device mounted on FR-4 PCB 400mm × 40mm × 1.5mm

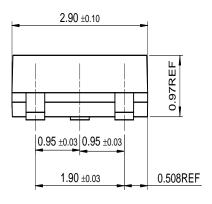
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Package Dimensions

SOT-23







Dimensions in Millimeters

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